

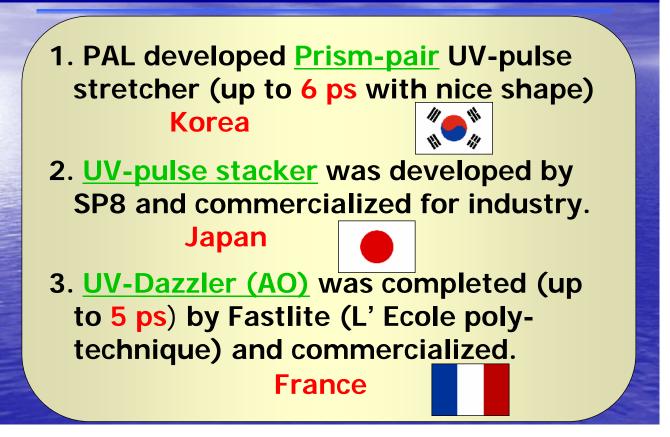
Pulse-stacker-based square pulse (>10ps) shaping system

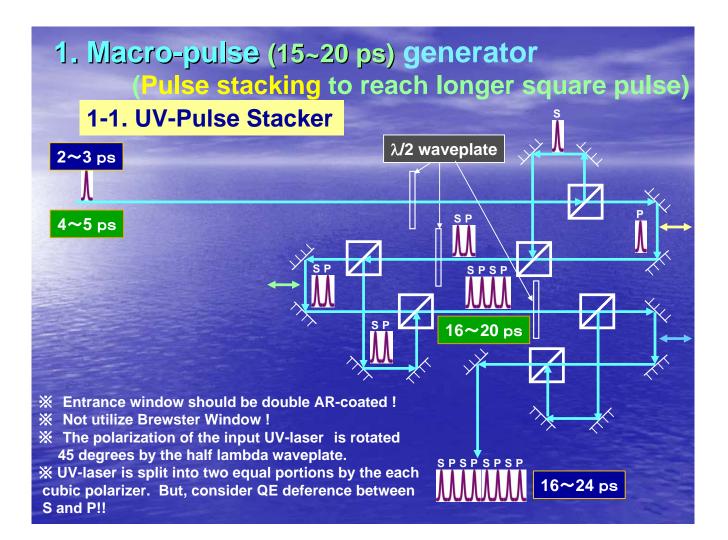
### Hiromistu Tomizawa

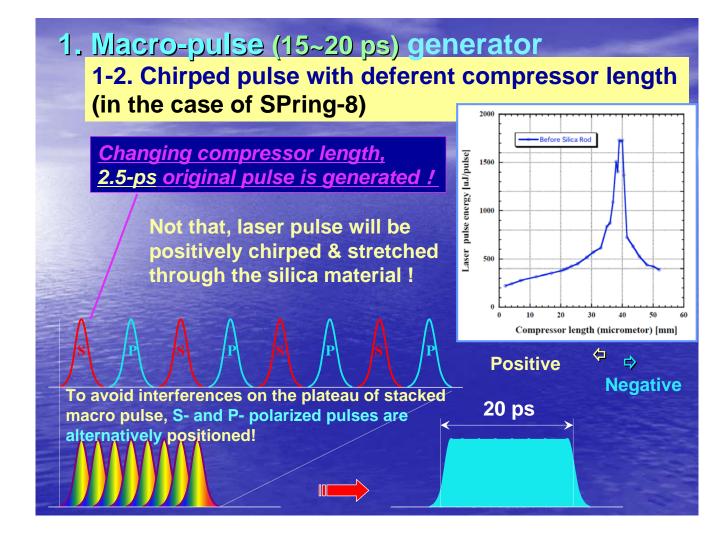
Accelerator Division, Japan Synchrotron Radiation Research Institute (SPring-8)

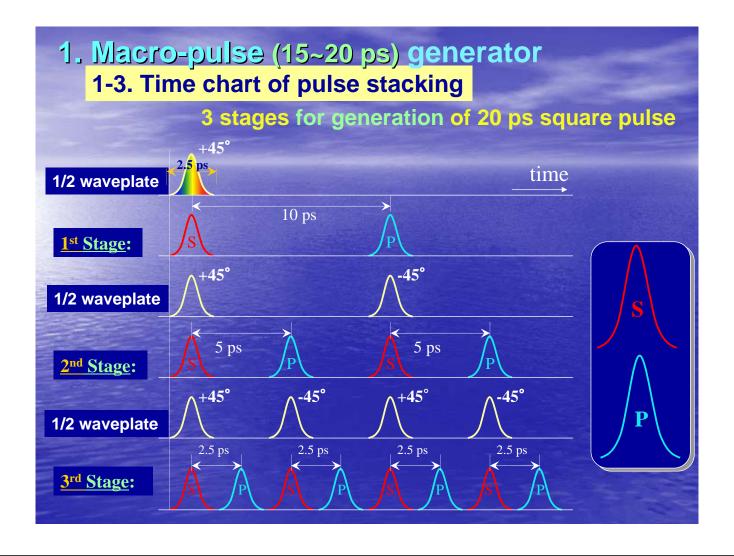
- U\_ Intro. ~ Recent progress in UV-pulse (>10 ps) shaping ~
- 1. Macro-pulse (15~20 ps) generation with UV-pulse stacker
- 2. Passive micro-pulse preparation - Prism-pair UV-stretcher + Pulse Stacker
- 3. Adaptive micro-pulse preparation - UV- & IR-DAZZLER feedback sys.+ Pulse Stacker
- 4. Summary for generation of 15~20-ps UV- Square laser pulse

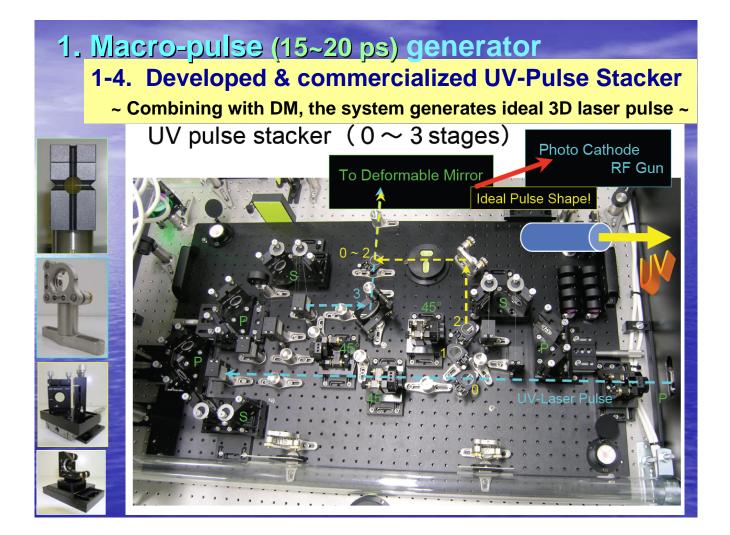
O. ~10-ps pulse-shaping development in UV (~263 nm): In the year 2006, UV-shaping technologies are matured!

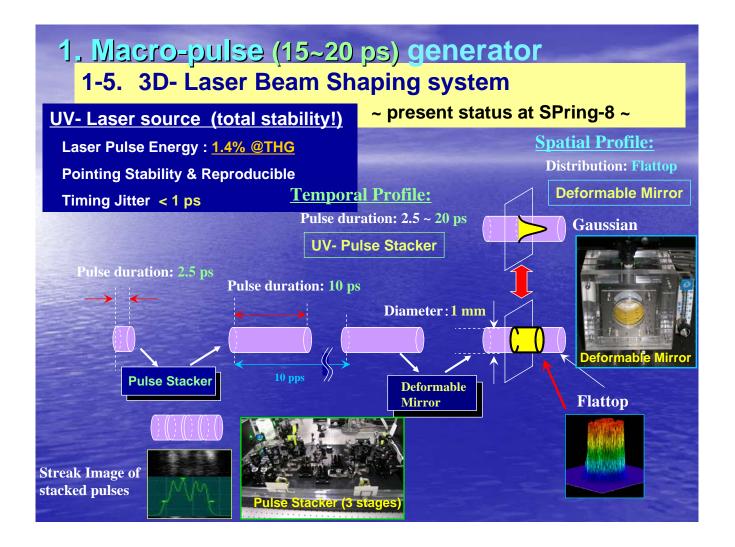


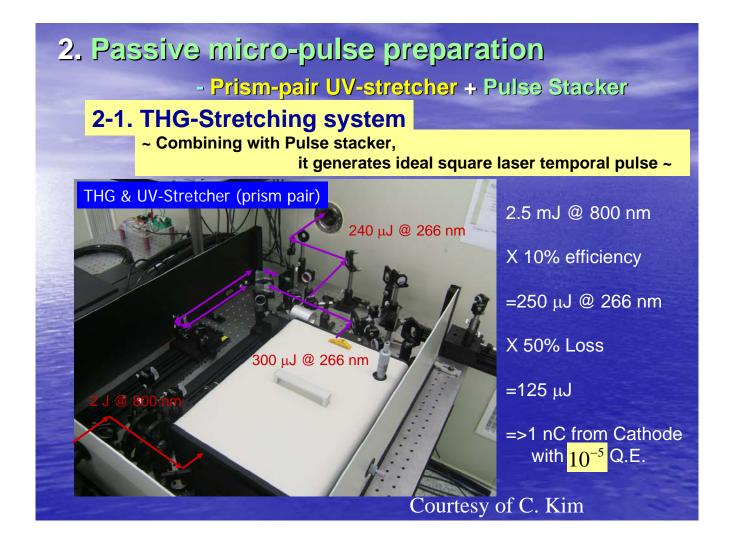












## 2. Passive micro-pulse preparation

#### - Prism-pair UV-stretcher + Pulse Stacker

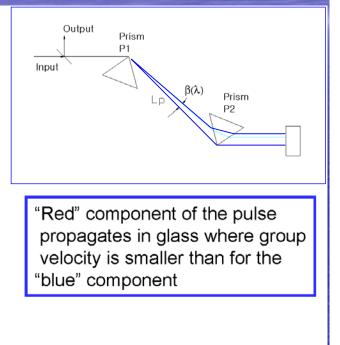
## **2-2. Prism-Pair Dispersion**

- Prism pair has been traditionally designed to compensate the GVD in the laser cavity, and to compress the output pulse.
- Prism-pair produces a negative GVD
  - GVD=  $(\lambda^3/2\pi c^2)d^2P/d\lambda^2$

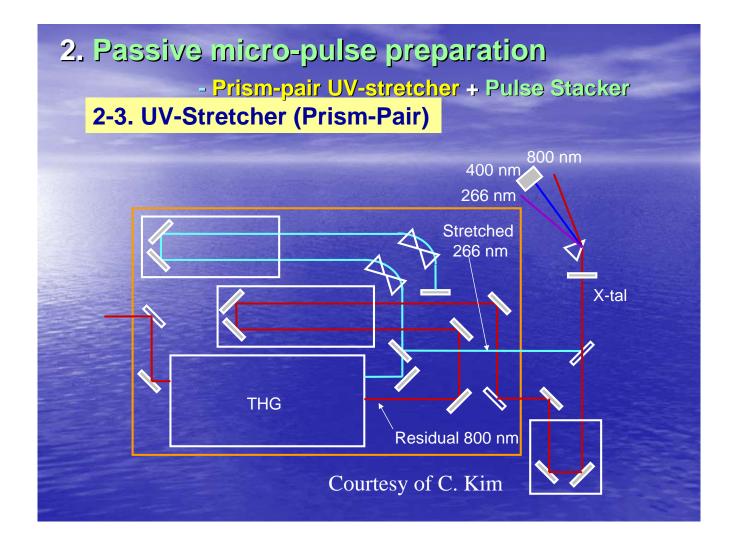
Path length P=2L<sub>p</sub>cos ( $\beta(\lambda)$ )

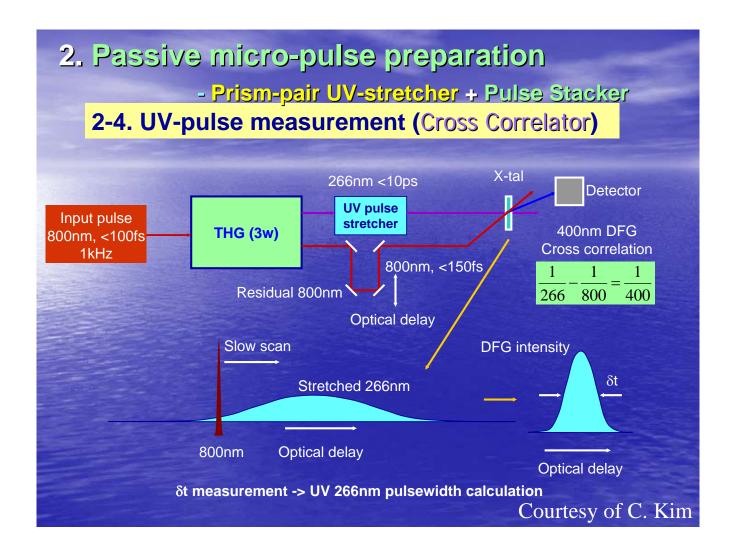
- $L_p$ = distance between P1 & P2
- GVD~ -( $4\lambda^{3}L_{p}/\pi c^{2}$ )( $dn/d\lambda$ )<sup>2</sup>
  - $= -550 fs^2/cm \times L_p(cm)$

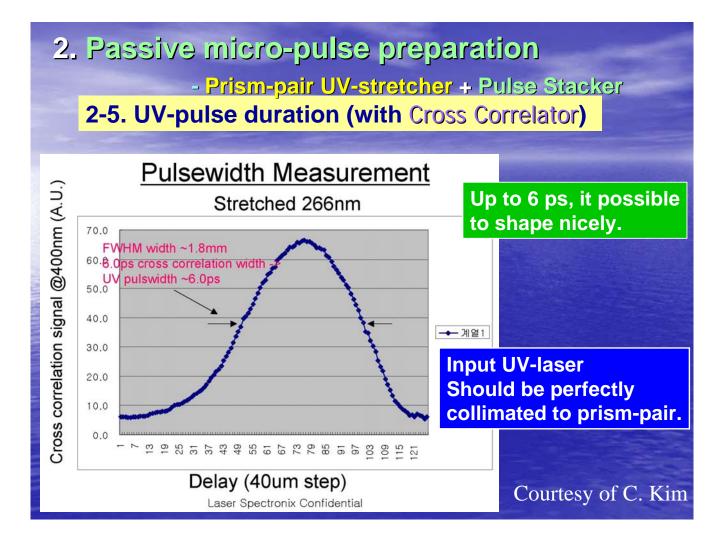
for fused silica at 266nm

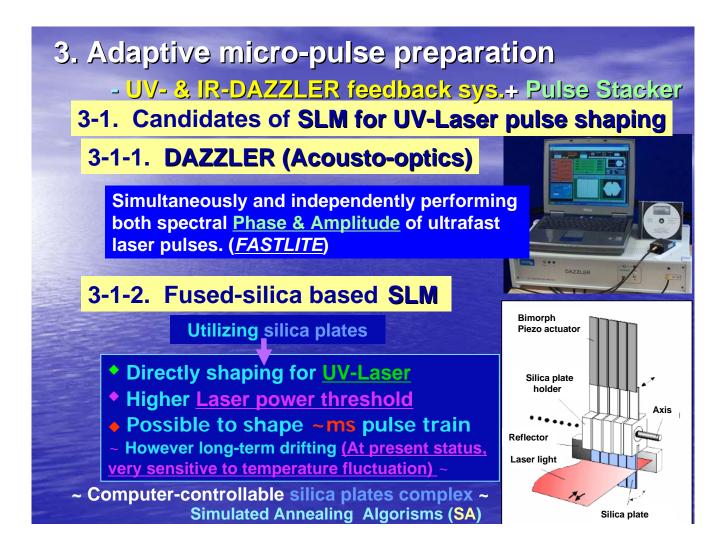


#### Courtesy of C. Kim

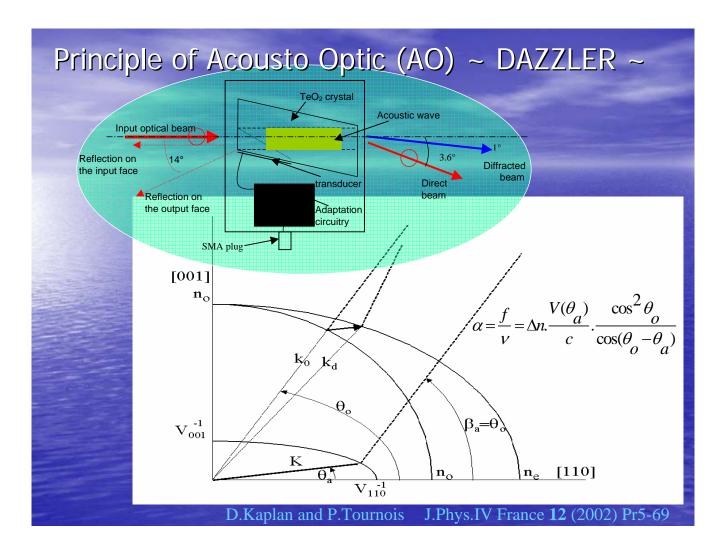


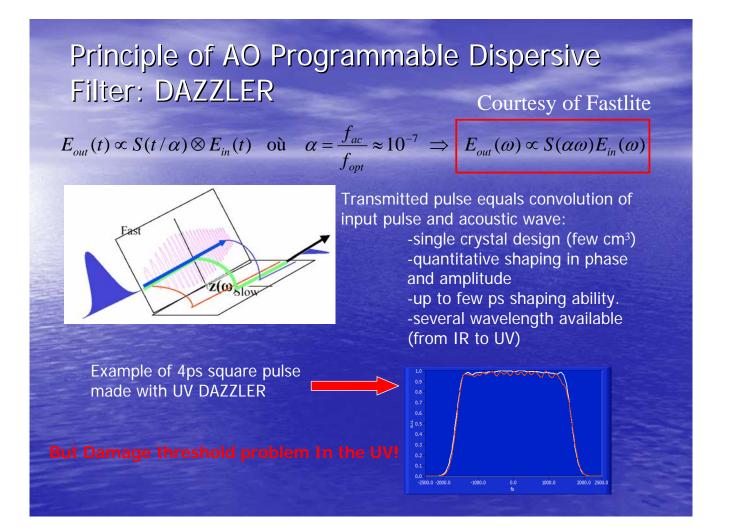


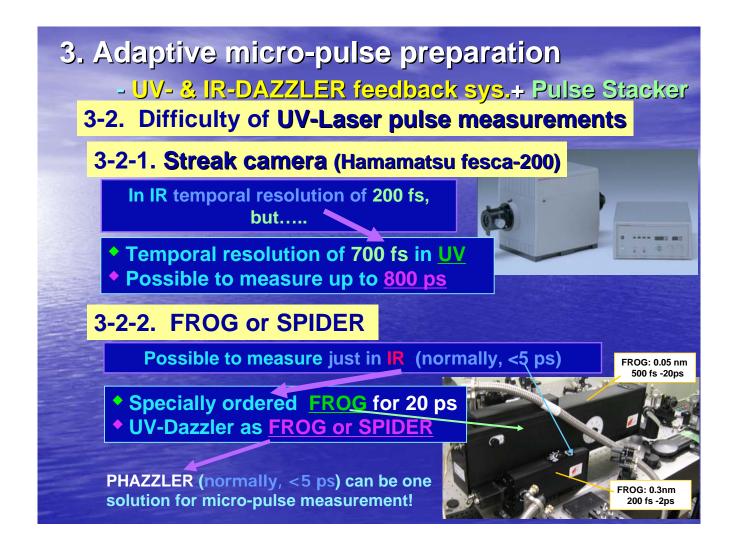


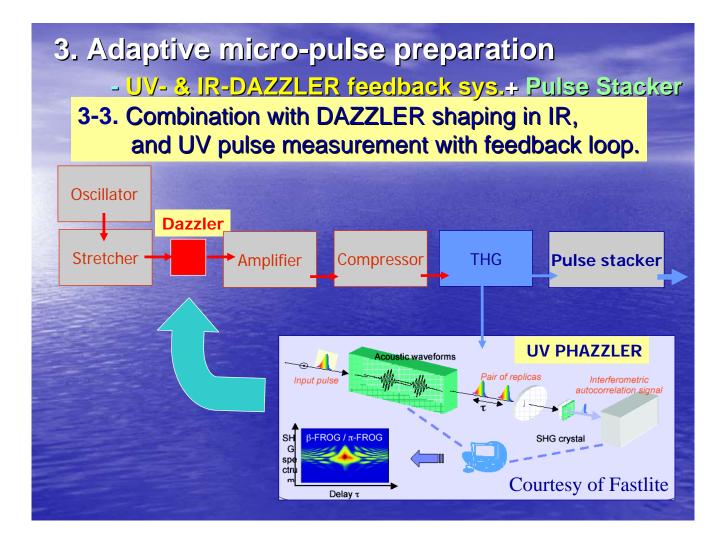


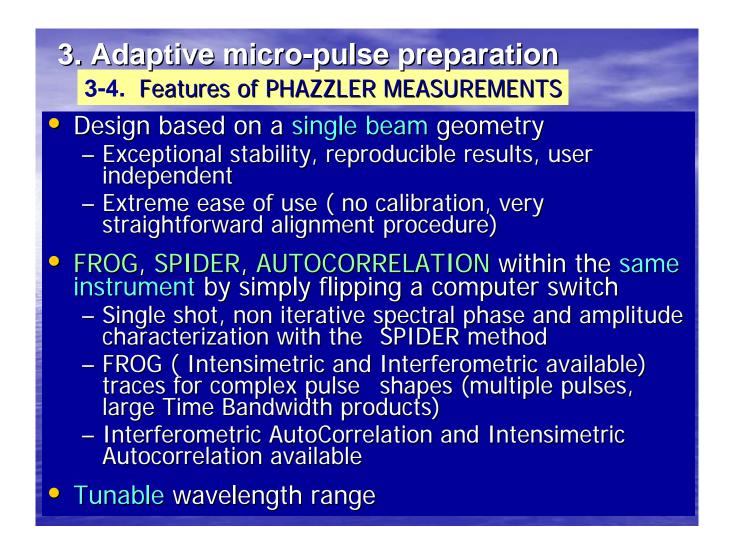
Compared with other type SLM						
Maker name	Cyber Laser Inc.	CRI	Meadlark	Jenoptik	Hamamatsu	FASTLITE
Product name	SP8 test SLM	SLM-128	SSP -256 - λ	SLM640/12	X8267	T-UV200-300
wavelength	<b>200 nm~</b> limited by gratings & optics	400 nm∼	400 nm∼	400 nm∼	350 nm∼	200~300nm
transparency	99%	94%	90%	95%	90% (Reflective)	50%
Total efficiency (0.1 nm/pixel)	20% in IR depends on input bandwidth (20 nm)	~ 40% in IR depends on input bandwidth (20 nm)	~ 70% in IR input bandwidth (< 26nm)	~ 70% in IR input bandwidth (< 64 nm)	~ 70% in IR input bandwidth (< 100 nm)	<b>30-50% in UV</b> depends on shaping
Damage threshold for amplified pulses (10 Hz)	1TW/cm <sup>2</sup> (100mJ/puise)	500MW/cm <sup>2</sup> (50 <i>µ</i> J/ pulse)	500MW/cm <sup>2</sup> (50 μ J/ pulse)	2 GW/cm <sup>2</sup> (100 µ J/ pulse)	2GW/cm <sup>2</sup> (200 µ J/ pulse)	1GW/cm <sup>2</sup> (100 μ J/ pulse)
Operating speed	50ms	100 ms	100 ms	100 ms	500 ms	0.04ms
Pixel number	48	128	256	640	1024	None (No dead space)
others	Whole system is packaged	Only SLM	Only SLM	Only SLM	Only SLM	Whole system is packaged
					•••	
Fused silica type:         Liquid crystal type           Mechanical control         Liquid crystal type					Electrical addressed type	AOPDF type

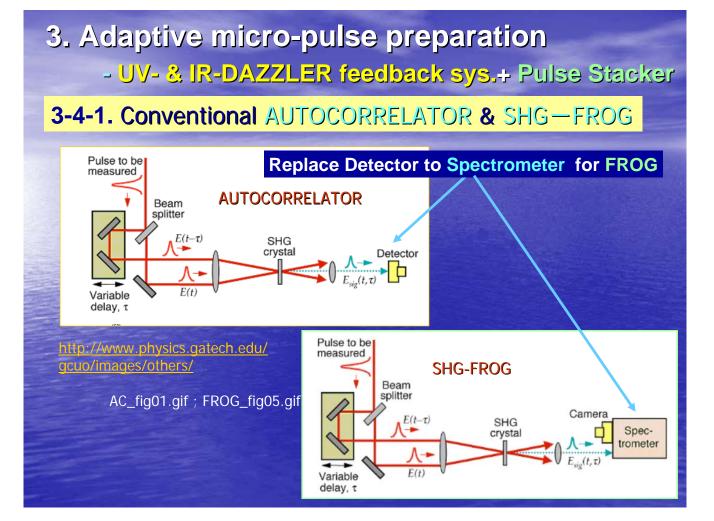






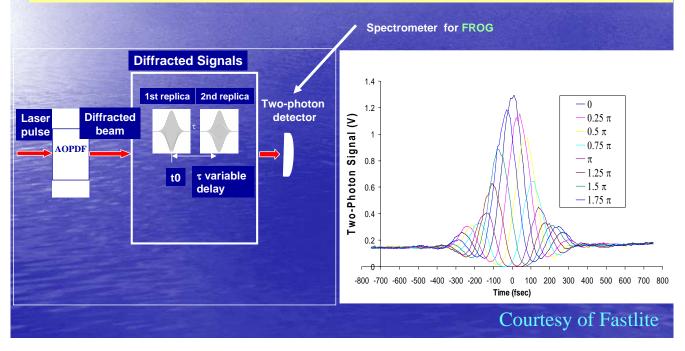


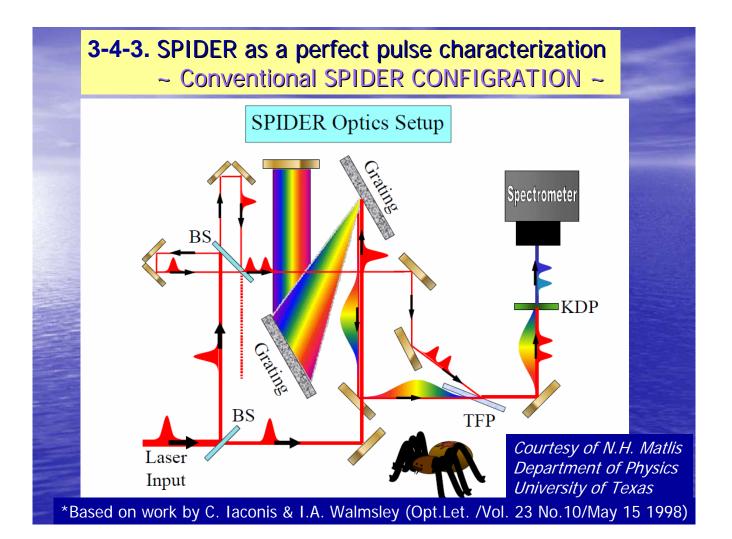


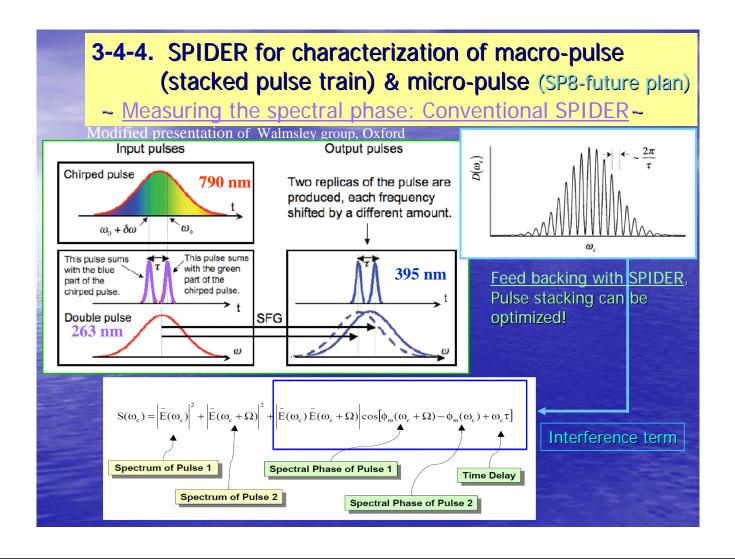


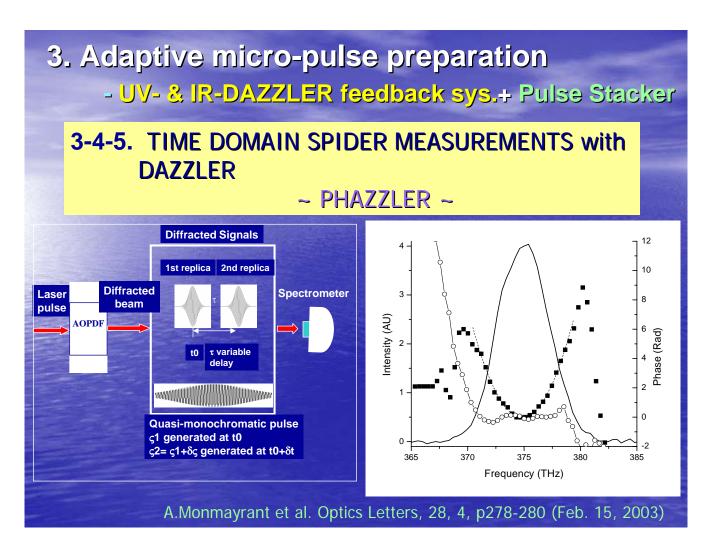
# 3. Adaptive micro-pulse preparation - UV- & IR-DAZZLER feedback sys.+ Pulse Stacker

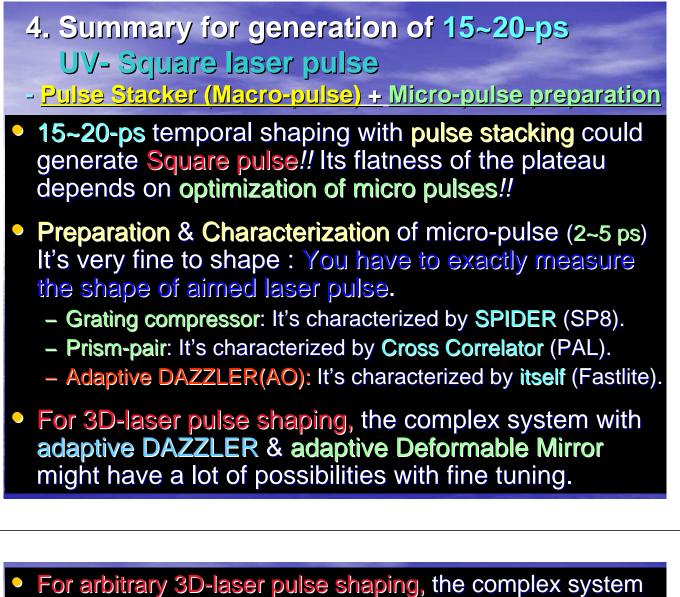
## **3-4-2. BASEBAND INTERFEROMETRIC** AUTOCORRELATION PULSE MEASUREMENTS with DAZZLER ~ PHAZZLER ~







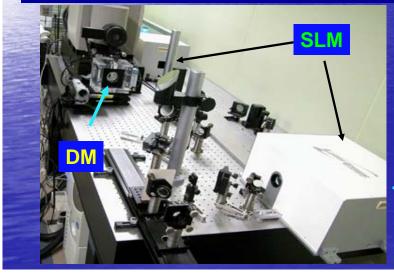




with adaptive Silica-SLM & adaptive DM should be the goal for any case. Especially, It can be utilized for multibunch beam shaping.

A) Computer-aided Silica-SLM (Spatial Light Modulator)
 → Rectangular Pulse shaping (Arbitrary Shape)

 B) Computer-aided DM (Deformable mirror)
 → Flattop spatial profile (Arbitrary Shape)



**Automatic Control Optics** 

- Spatial shaping (DM)
- Pulse shaping (SLM)
- Wave front Control (DM)

